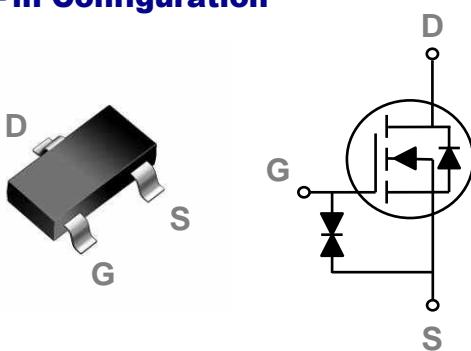


### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### SOT523 Pin Configuration



BVDSS	RDSON	ID
20V	300mΩ	800mA

### Features

- 20V, 800mA,  $RDS(ON) = 300m\Omega @ VGS = 4.5V$
- Improved dv/dt capability
- Fast switching
- Green Device Available
- Suit for 1.5V Gate Drive Applications

### Applications

- Notebook
- Load Switch
- Battery Protection
- Hand-held Instruments

### Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	20	V
$V_{GS}$	Gate-Source Voltage	$\pm 8$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ C$ )	800	mA
	Drain Current – Continuous ( $T_c=100^\circ C$ )	510	mA
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	3.2	A
$P_D$	Power Dissipation ( $T_c=25^\circ C$ )	312	mW
	Power Dissipation – Derate above $25^\circ C$	2.5	mW/ $^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	400	$^\circ C/W$



20V N-Channel MOSFETs

PDEU2320Y

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$	20	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{BV}_{\text{DSS}}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$	---	-0.01	---	$\text{V}/^\circ\text{C}$
$I_{\text{DS}}^{\text{SS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=20\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=16\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 6\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 20$	$\mu\text{A}$

**On Characteristics**

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=0.5\text{A}$	---	200	300	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}$ , $I_{\text{D}}=0.4\text{A}$	---	235	400	
		$V_{\text{GS}}=1.8\text{V}$ , $I_{\text{D}}=0.2\text{A}$	---	295	550	
		$V_{\text{GS}}=1.5\text{V}$ , $I_{\text{D}}=0.1\text{A}$	---	365	800	
		$V_{\text{GS}}=1.2\text{V}$ , $I_{\text{D}}=0.1\text{A}$	---	600	1500	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=250\mu\text{A}$	0.3	0.6	1.0	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	3	---	$\text{mV}/^\circ\text{C}$

**Dynamic and switching Characteristics**

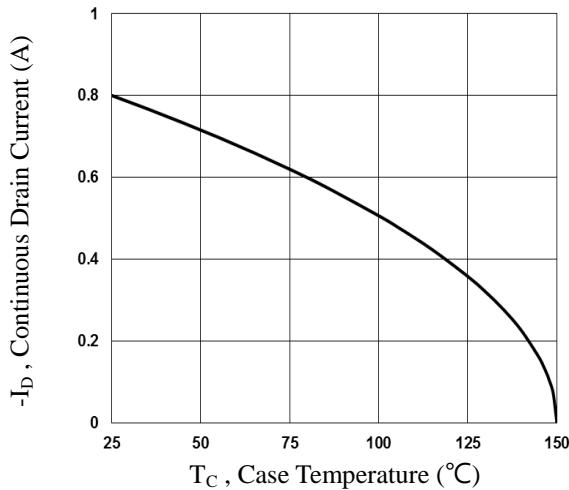
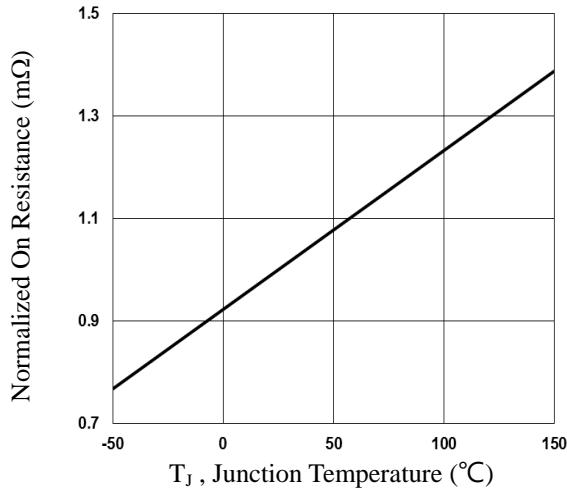
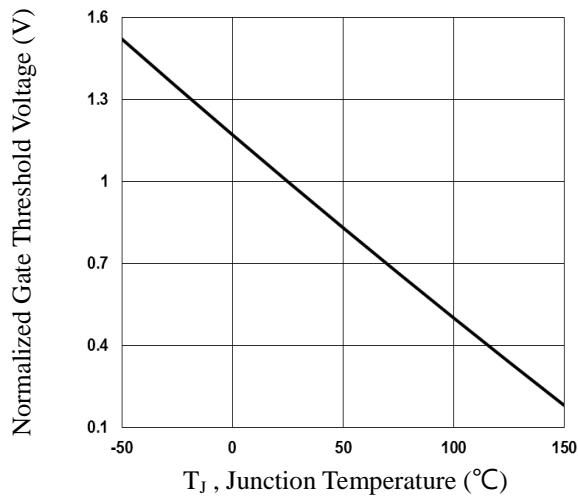
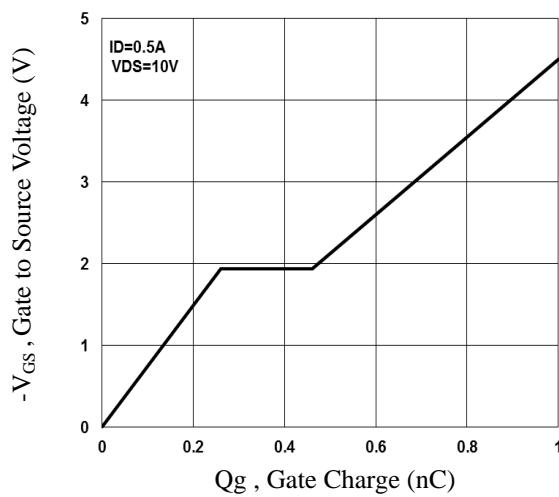
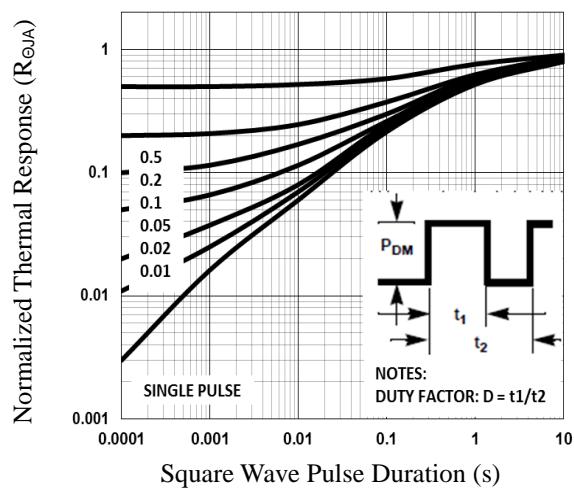
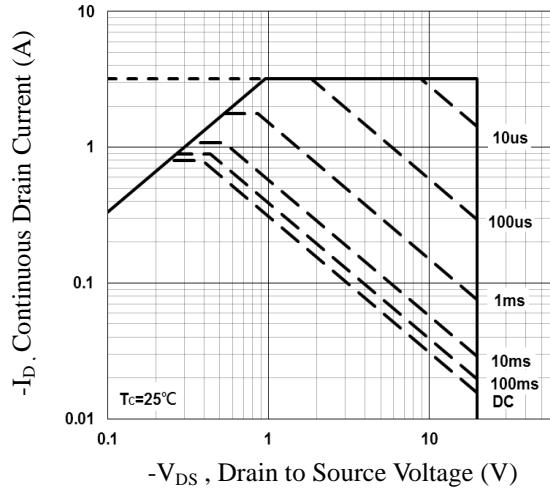
$Q_g$	Total Gate Charge <sup>2,3</sup>	$V_{\text{DS}}=10\text{V}$ , $V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=0.5\text{A}$	---	1	2	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>2,3</sup>		---	0.26	0.5	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>2,3</sup>		---	0.2	0.4	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>2,3</sup>	$V_{\text{DD}}=10\text{V}$ , $V_{\text{GS}}=4.5\text{V}$ , $R_{\text{G}}=10\Omega$ $I_{\text{D}}=0.5\text{A}$	---	5	10	ns
$T_r$	Rise Time <sup>2,3</sup>		---	3.5	7	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>2,3</sup>		---	14	28	
$T_f$	Fall Time <sup>2,3</sup>		---	6	12	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=10\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	38.2	75	pF
$C_{\text{oss}}$	Output Capacitance		---	14.4	28	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	6	12	

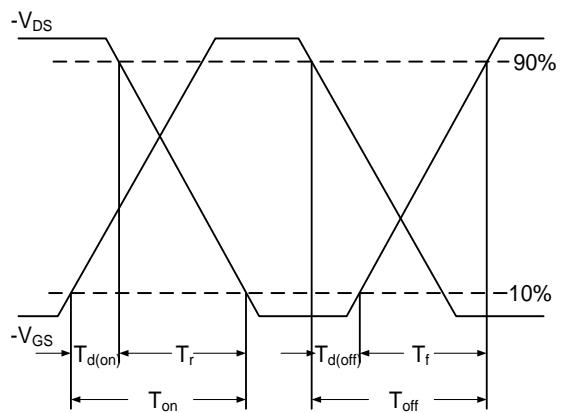
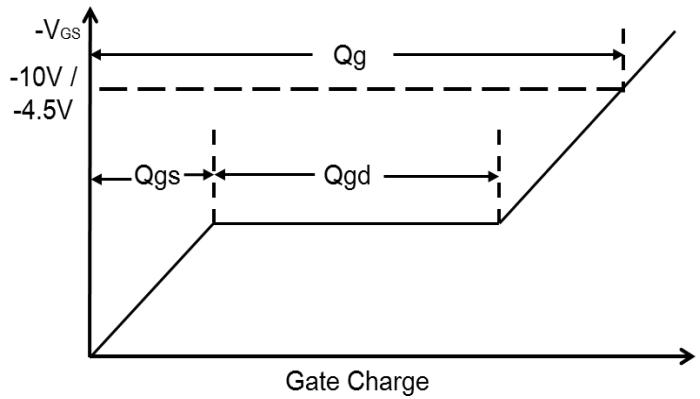
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	0.8	A
$I_{\text{SM}}$	Pulsed Source Current		---	---	1.6	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=0.2\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V

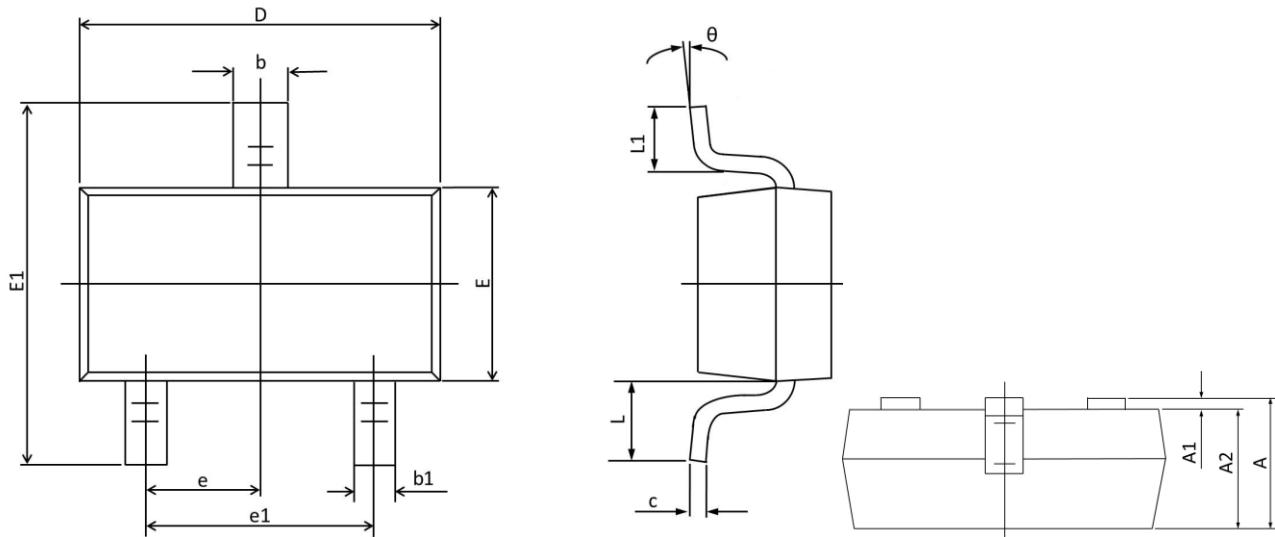
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs. T<sub>C</sub>**

**Fig.2 Normalized RDS(on) vs. T<sub>J</sub>**

**Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>**

**Fig.4 Gate Charge Waveform**

**Fig.5 Normalized Transient Response**

**Fig.6 Maximum Safe Operation Area**


**Fig.7** Switching Time Waveform

**Fig.8** Gate Charge Waveform

## SOT523 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	0.900	0.700	0.035	0.028
A1	0.100	0.000	0.004	0.000
A2	0.800	0.700	0.031	0.028
b	0.350	0.250	0.014	0.010
b1	0.250	0.150	0.010	0.006
c	0.200	0.100	0.008	0.004
D	1.750	1.500	0.069	0.059
E	0.900	0.700	0.035	0.028
E1	1.750	1.400	0.069	0.055
e	0.5TYP.		0.02TYP.	
e1	1.100	0.900	0.043	0.035
L	0.460	0.300	0.018	0.012
L1	0.460	0.260	0.018	0.010
θ	8°	0°	8°	0°